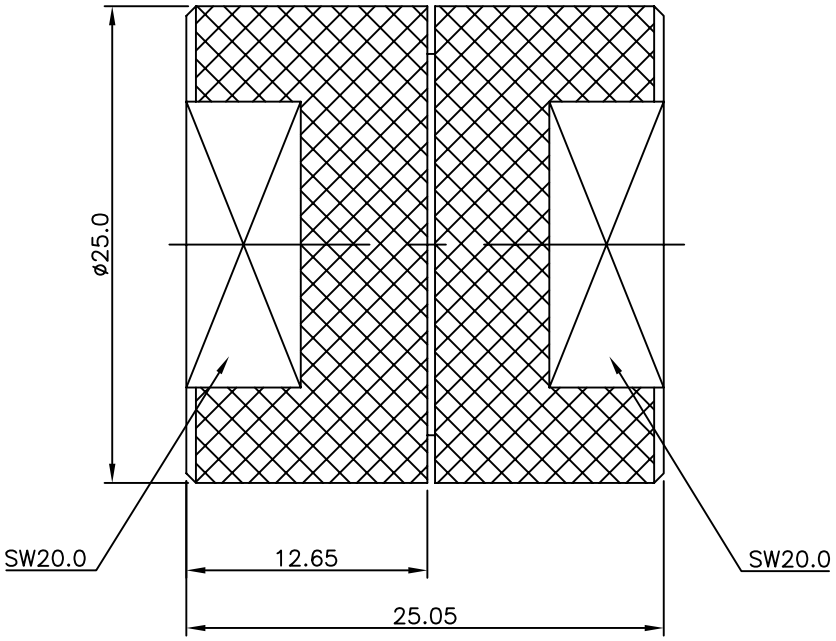
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2021.05.20.



NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
8	BOLT M2-8mm 접시머리	4	SUS	Passivated	DBT00062-N/1
7	RESISTOR	1	——	——	DRE00057-N/1
6	COVER	1	MBsBD C3604BD-F	Gold Plate	DCV00055-5/1
5	INSULATOR	1	TEFLON		DIN01400-N/1
4	CONTACT	1	BeCu C17300	Gold Plate	DCT01728-5/1
3	BODY (C)	1	MBsBD C3604BD-F	Nickel Plate	DBD02201-5/1
2	BODY (B)	1	MBsBD C3604BD-F	Nickel Plate	DBD04732-5/1
1	BODY (A)	1	MBsBD C3604BD-F	Nickel Plate	DBD04731-5/1

TOLERANCE	Decimal ±0.1	DATE	2021. 05. 20.
	Angle ±1°	APPROVED BY	I.C.KIM
		CHECKED BY	
MATERIAL	——	DRAWN BY	S.Y.EUN
FINISH	——	SCALE 2.5/1	UNIT mm

KJ COMTECH
KJ COMTECH CO.,LTD.
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
BMBC SOLDER END 측정용 TERM (2W)

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